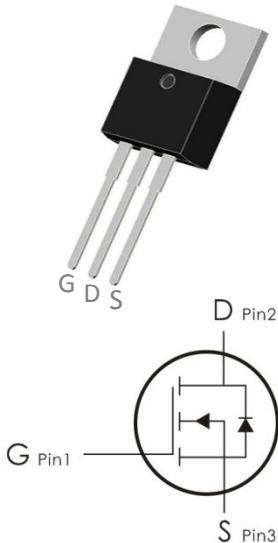


Description:

This N-Channel MOSFET uses advanced SGT technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.

Features:

- 1) $V_{DS}=100V, I_D=90A, R_{DS(on)}<7.5m\Omega @ V_{GS}=10V$ (Typ: $6.5m\Omega$)
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low $R_{DS(on)}$.
- 5) Excellent package for good heat dissipation.



Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
DOP90N10-L	90N10-L	TO- 220	50 pcs/Tube

Absolute Maximum Ratings: ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current	90	A
	Continuous Drain Current- $T_C=100^\circ C$	63	
I_{DM}	Pulsed Drain Current ¹	360	
P_D	Power Dissipation	85	W
E_{AS}	Single pulse avalanche energy ²	156	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55-+150	°C

Thermal Characteristics:

Symbol	Parameter	Max	Units
R_{eJC}	Thermal Resistance,Junction to Case	1.5	°C/W

Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=100\text{V}$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	± 100	nA
On Characteristics						
$V_{\text{GS}(\text{th})}$	Gate-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	1.3	2.1	2.7	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance ³	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}$	---	6.5	7.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$	---	8.4	10	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2520	---	pF
C_{oss}	Output Capacitance		---	1254	--	
C_{rss}	Reverse Transfer Capacitance		---	47	---	
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=50\text{V}, I_{\text{D}}=20\text{A}, R_{\text{ENG}}=3 \Omega, V_{\text{GS}}=10\text{V}$	---	11.4	---	ns
t_r	Rise Time		---	15.75	---	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		---	31.35	---	ns
t_f	Fall Time		---	21	---	ns
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=20\text{A}$	---	42	---	nc
Q_{gs}	Gate-Source Charge		---	8.5	---	nc
Q_{gd}	Gate-Drain "Miller" Charge		---	7.35	---	nc
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=30\text{A}$	---	---	1.2	V
I_s	Continuous Drain Current	$V_D = V_G = 0$	---	---	90	A
I_{SM}	Pulsed Drain Current		---	---	360	A
Tr_{rr}	Reverse Recovery Time	$I_F=20\text{A}, T_J=25^\circ\text{C}$	---	55	---	ns
Q_{rr}	Reverse Recovery Charge		---	70	---	nC

**Notes:**

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. E_{AS} condition: Starting T_J=25C, V_{DD}=50V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=25A
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

Typical Characteristics: (T_C=25°C unless otherwise noted)

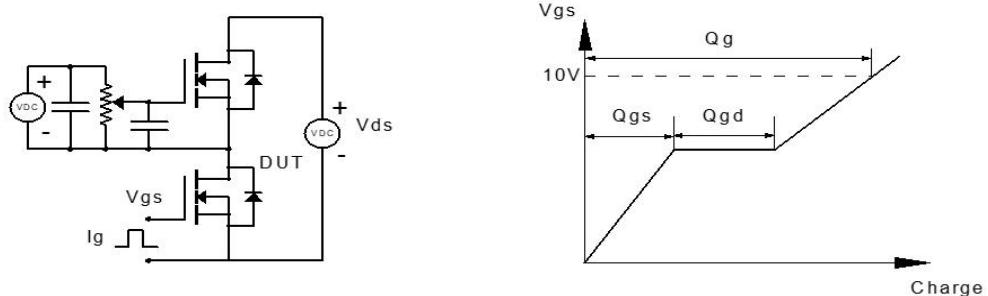


Figure 1: Gate Charge Test Circuit & Waveform

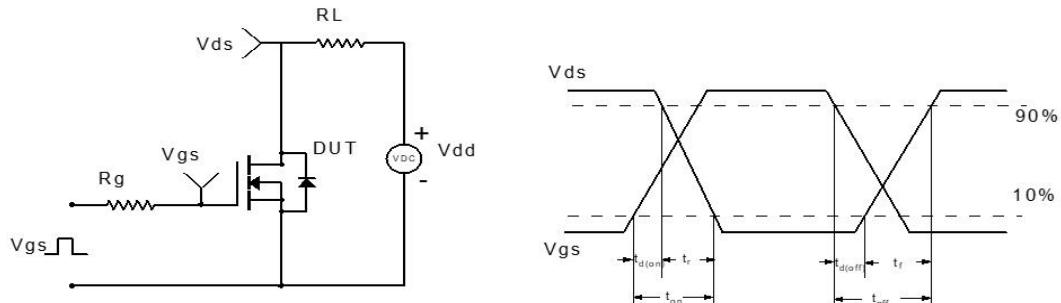


Figure 2: Resistive Switching Test Circuit & Waveform

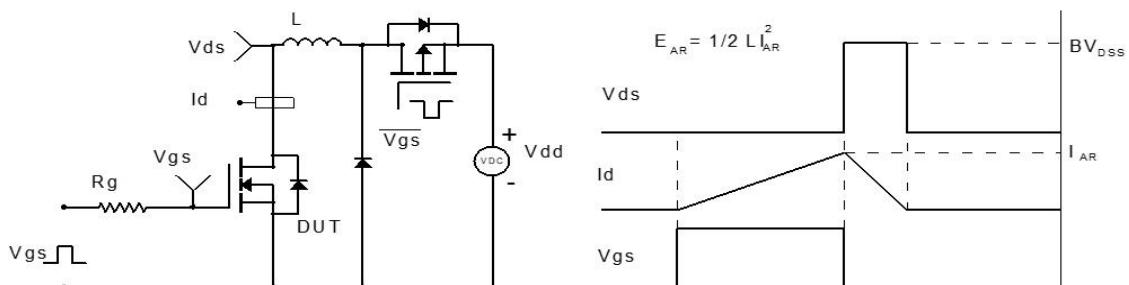


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

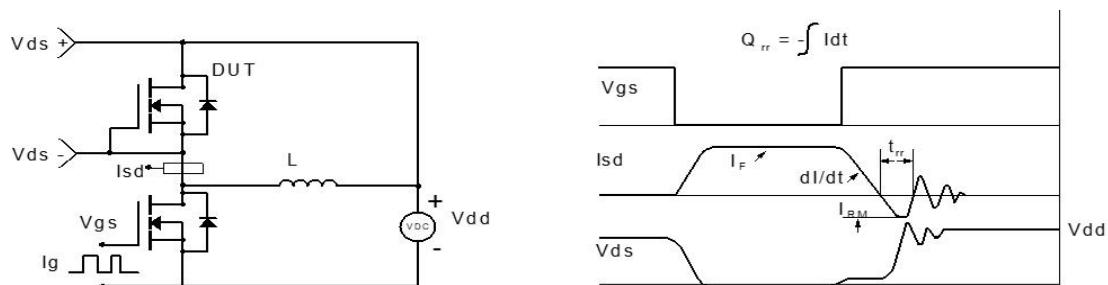
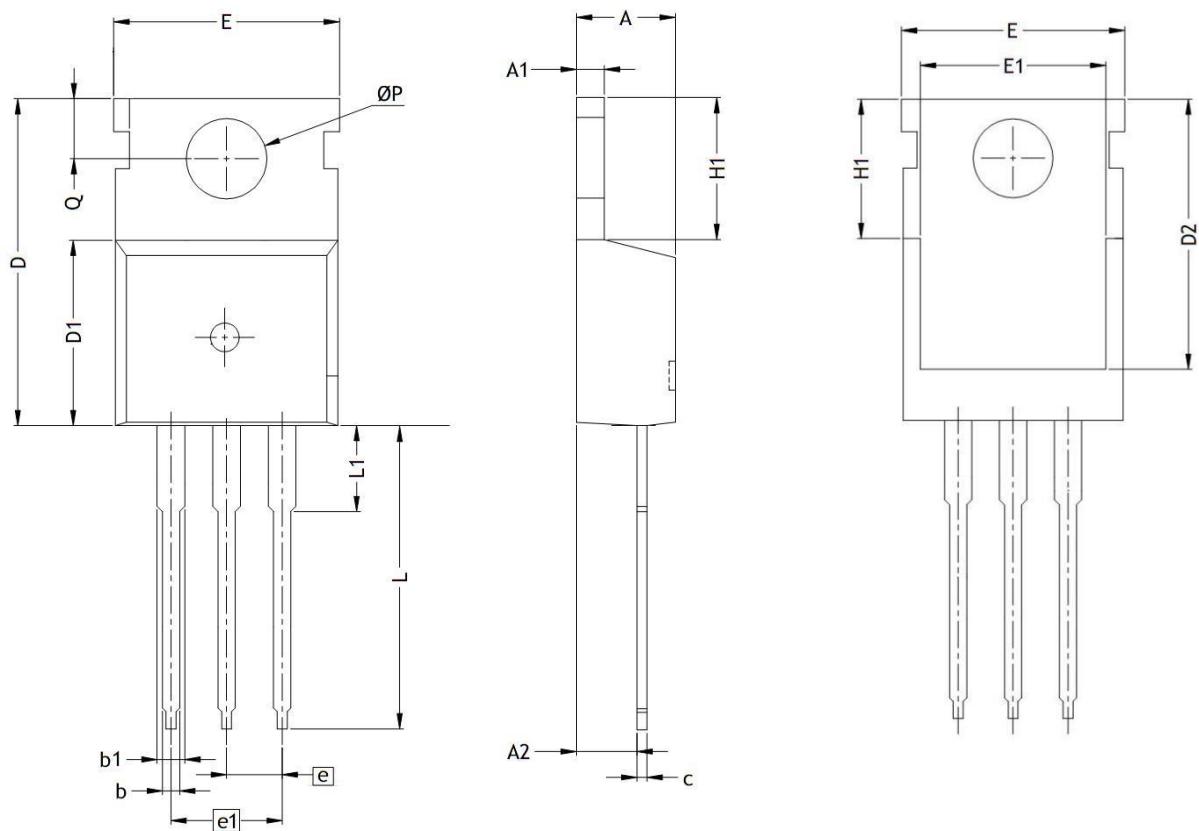


Figure 4: Diode Recovery Test Circuit & Waveform

V1.1

TO-220 Package Information:

UNIT: mm

SYMBOLS	A	A1	A2	b	b1	c	D	D1	D2	E	E1	e
MIN	4.25	1.25	2.35	0.7	1.15	0.45	14.35	8.80	13.05	9.90	7.85	2.540
MAX	4.65	1.35	2.55	0.9	1.75	0.60	15.95	9.50	13.65	10.35	8.85	BSC
SYMBOLS	e1	H1	L	L1	Q	ØP						
MIN	5.080	6.30	12.85	2.85	2.70	3.50						
MAX	BSC	6.65	13.50	3.25	2.90	3.70						

Marking Information:

①. Doingter LOGO

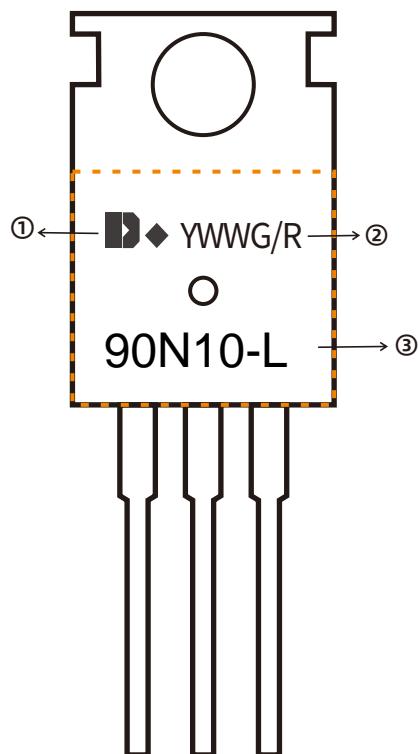
②. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)

G/R : G(Green) /R(Lead Free)

③. Part NO.



Previous Version

Version	Date	Subjects (major changes since last revision)
1.1	2024-09-12	Release of final version

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